This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of claims:

Claims 1-10 canceled.

Claim 11 (new): A method for making contact between at least one module for wire-free radio standards and at least one application, the method comprising:

providing contact surfaces on a side of the module which is intended to make contact with the application; and

providing contact surfaces, which may interact with the contact surfaces of the module, on a side of the application which is intended to make contact with the module, wherein the respective contact surfaces of the module and application are formed by a metallic coating with a low resistance, the low resistance being at least one of electrical and thermal, and a connection is produced between the respective contact surfaces of the module and the application.

Claim 12 (new): A method for making contact between at least one module for wire-free radio standards and at least one application as claimed in Claim 11, further comprising providing a detachable connection between the respective contact surfaces of the module and the application via a mechanical apparatus which allows the module to be replaced by pushing the module in and out.

Claim 13 (new): A method for making contact between at least one module for wire-free radio standards and at least one application as claimed in Claim 11, wherein a firm connection is provided between respective contact surfaces of the module and the application.

Claim 14 (new): A method for making contact between at least one module for wire-free radio standards and at least one application as claimed in Claim 13, wherein the respective contact surfaces of the module and the application are one of soldered together and pressed together.

Claim 15 (new): A method for making contact between at least one module for wire-free radio standards and at least one application as claimed in Claim 11, wherein the respective contact surfaces of the module and the application are arranged in grid form.

Claim 16 (new): A combination of at least one module for wire-free radio standards and at least one application, comprising:

a module for wire-free radio standards; and

an application;

wherein the module includes contact surfaces on a side which is intended to make contact with the application, and the application includes contact surfaces on a side which is intended to make contact with the module, the respective contact surfaces of the module and the application interacting with each other and making contact therewith, with the respective contact surfaces of the module and the application being formed by a metallic coating with a low resistance, the resistance being at least one of electrical and thermal.

Claim 17 (new): A combination of at least one module for wire-free radio standards and at least one application as claimed in Claim 16, wherein the respective contact surfaces of the module and the application may be detachably connected to one another.

Claim 18 (new): A combination of at least one module for wire-free radio standards and at least one application as claimed in Claim 16, wherein the respective contact surfaces of the module and the application may be permanently connected to one another.

Claim 19 (new): A combination of at least one module for wire-free radio standards and at least one application as claimed in Claim 18, wherein the

respective contact surfaces of the module and the application may be soldered to one another.

Claim 20 (new): A combination of at least one module for wire-free radio standards and at least one application as claimed in Claim 16, wherein the respective contact surfaces of the module and the application are arranged in grid form.